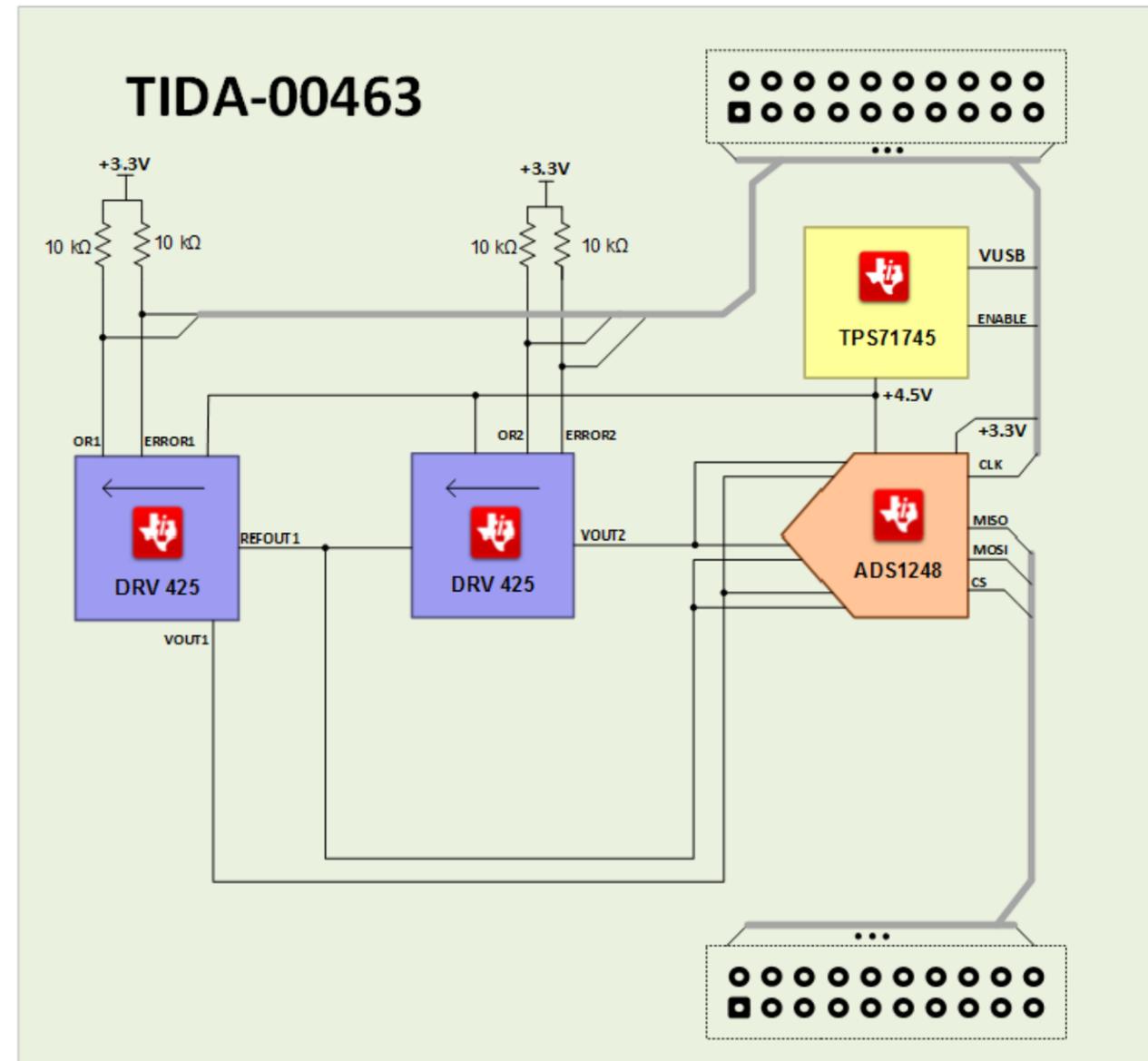
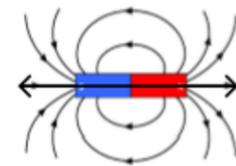


Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

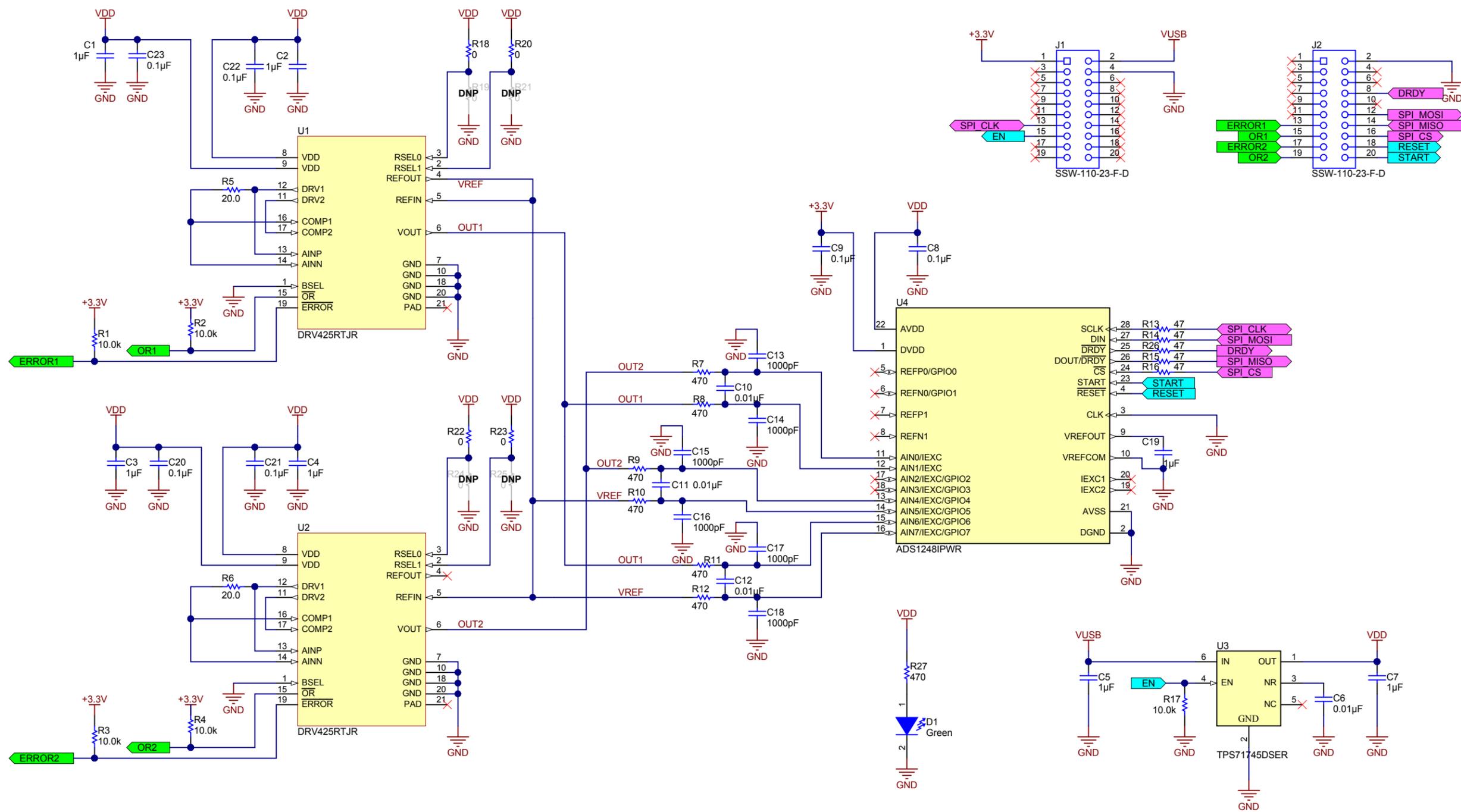


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Orderable: N/A	Designed for: Public Release	Mod. Date: 12/9/2015
TID #: TIDA-00463	Project Title: Fluxgate Based Displacement Sensor	
Number: TIDA-00463	Rev: E1	Sheet Title: TIDA-00463_CoverSheet
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Giovanni Campanella	File: TIDA-00463_CoverSheet_SchDoc	Size: B
Engineer: Giovanni Campanella	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/20/2015
TID #: TIDA-00463	Project Title: Fluxgate Based Displacement Sensor	
Number: TIDA-00463	Rev: E1	Sheet Title: TIDA-00463 Fluxgate
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Giovanni Campanella	File: TIDA-00463_Fluxgate.SchDoc	Size: B
Engineer: Giovanni Campanella	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	





PCB Number: TIDA-00463  
PCB Rev: E1

PCB LOGO  
Texas Instruments

PCB LOGO  
Pb-Free Symbol

PCB LOGO  
FCC disclaimer

Label Table	
Variant	Label Text
001	VREF=VDD/2

LBL1  
PCB Label  
Size: 0.65" x 0.20 "

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/24/2015	<p>TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2015</p>
TID #: TIDA-00463	Project Title: Fluxgate Based Displacement Sensor		
Number: TIDA-00463	Rev: E1	Sheet Title: TIDA-00463 Hardware	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: Giovanni Campanella	File: TIDA-00463_Hardware.SchDoc	Size: B	
Engineer: Giovanni Campanella	Contact: http://www.ti.com/support		

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